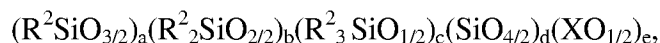


IN THE CLAIMS:

1. (Previously Presented) A curable organopolysiloxane composition comprising:

(A) a straight-chain organopolysiloxane having per molecule at least two silicon-bonded alkenyl groups and at least one silicon-bonded aryl group;

(B) a branched-chain organopolysiloxane having an average unit formula:



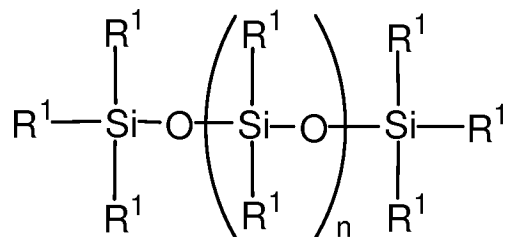
where each R^2 is the same or different substituted or unsubstituted monovalent hydrocarbon group, 0.1 to 40 mole % of all R^2 's are alkenyl groups, more than 10 mole % of all R^2 's are aryl groups, X is a hydrogen atom or an alkyl group, a is a positive number, b is 0 or a positive number, c is 0 or a positive number, d is 0 or a positive number, e is 0 or a positive number, b/a is 0 to 10, c/a is 0 to 0.5, $d/(a + b + c + d)$ is 0 to 0.3, and $e/(a + b + c + d)$ is 0 to 0.4, and where component (B) is used in a weight ratio of 1/99 to 99/1 based on the weight of component (A);

(C) an organopolysiloxane having per molecule at least two silicon-bonded hydrogen atoms, where component (C) is used in an amount of 1 to 200 parts by weight for each 100 parts by weight of the total weight of parts (A) and (B); and

(D) a hydrosilylation catalyst in an amount sufficient to promote curing of the composition.

2. (Original) The curable organopolysiloxane composition of claim 1, where component (A) has a content of silicon-bonded aryl groups not less than 40 mole % of all silicon-bonded organic groups in component (A).

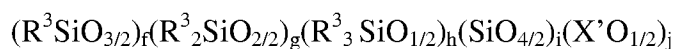
3. (Original) The curable organopolysiloxane composition of claim 1, where component (A) is an organopolysiloxane represented by the general formula:



where each R^1 comprises the same or different substituted or unsubstituted monovalent hydrocarbon groups, at least two R^1 's comprise alkenyl groups, at least one R^1 comprises an aryl group, and n is an integer from 5 to 1000.

4. (Cancelled)

5. (Currently Amended) The curable organopolysiloxane composition of claim 1, where all or a portion of component (C) has average unit formula:



where each R^3 is the same or different ~~alkenyl groups~~, substituted or unsubstituted monovalent hydrocarbon groups except for alkenyl groups, or hydrogen atoms; 0.1 to 40 mole % of all R^3 's are hydrogen atoms; more than 10 mole % of all R^3 's are aryl groups; X' is a hydrogen atom or an alkyl group, f is a positive number, g is 0 or a positive number, h is 0 or a positive number, i is 0 or a positive number, j is 0 or a positive number, g/f is 0 to 10, h/f is 0 to 0.5, $i/(f + g + h + i)$ is 0 to 0.3, and $j/(f + g + h + i)$ is 0 to 0.4.

6. (Previously Presented) The curable organopolysiloxane composition of claim 1, where an index of refraction at 25°C for visible light having a wavelength of 589 nm passing through an object obtained by curing the curable organopolysiloxane composition of claim 1 is equal to or exceeds 1.5.

7. (Previously Presented) The curable organopolysiloxane composition of claim 1, where light permeability at 25°C for visible light passing through an object obtained by curing the curable organopolysiloxane composition of claim 1 is equal to or exceeds 80%.

Claims 8-9. (Cancelled).

10. (Currently Amended) A curable organopolysiloxane composition comprising:

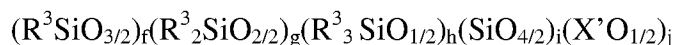
(A) a straight-chain organopolysiloxane having per molecule at least two silicon-bonded alkenyl groups and at least one silicon-bonded aryl group;

(B) a branched-chain organopolysiloxane with siloxane units represented by the general formula:



where R is a substituted or unsubstituted monovalent hydrocarbon group, and where component (B) has per molecule, at least one silicon-bonded alkenyl group and at least one silicon-bonded aryl group, and where component (B) is used in a weight ratio of 1/99 to 99/1 based on the weight of component (A);

(C) an organopolysiloxane having per molecule at least two silicon-bonded hydrogen atoms, where all or a portion of component (C) has an average unit formula:

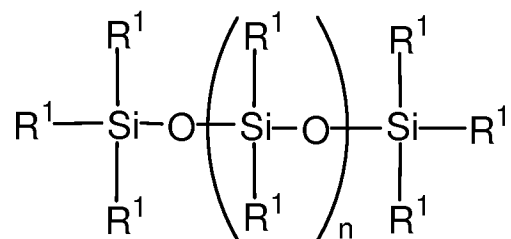


where each R^3 is the same or different ~~alkenyl groups~~, substituted or unsubstituted monovalent hydrocarbon groups except for alkenyl groups, or hydrogen atoms; 0.1 to 40 mole % of all R^3 's are hydrogen atoms; more than 10 mole % of all R^3 's are aryl groups; X' is a hydrogen atom or an alkyl group, f is a positive number, g is 0 or a positive number, h is 0 or a positive number, i is 0 or a positive number, j is 0 or a positive number, g/f is 0 to 10, h/f is 0 to 0.5, $i/(f + g + h + i)$ is 0 to 0.3, and $j/(f + g + h + i)$ is 0 to 0.4, and where component (C) is used in an amount of 1 to 200 parts by weight for each 100 parts by weight of the total weight of parts (A) and (B); and

(D) a hydrosilylation catalyst in an amount sufficient to promote curing of the composition.

11. (Previously Presented) The curable organopolysiloxane composition of claim 10, where component (A) has a content of silicon-bonded aryl groups not less than 40 mole % of all silicon-bonded organic groups in component (A).

12. (Previously Presented) The curable organopolysiloxane composition of claim 10, where component (A) is an organopolysiloxane represented by the general formula:



where each R^1 comprises the same or different substituted or unsubstituted monovalent hydrocarbon groups, at least two R^1 's comprise alkenyl groups, at least one R^1 comprises an aryl group, and n is an integer from 5 to 1000.

13. (Previously Presented) A curable organopolysiloxane composition comprising:

(A) a straight-chain organopolysiloxane having per molecule at least two silicon-bonded alkenyl groups and at least one silicon-bonded aryl group;

(B) a branched-chain organopolysiloxane with siloxane units represented by the general formula:



where R is a substituted or unsubstituted monovalent hydrocarbon group, and where component (B) has per molecule, at least one silicon-bonded alkenyl group and at least one silicon-bonded aryl group, and where component (B) is used in a weight ratio of 1/99 to 99/1 based on the weight of component (A);

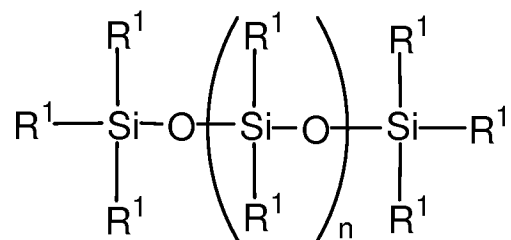
(C) an organopolysiloxane having per molecule at least two silicon-bonded hydrogen atoms, where component (C) is used in an amount of 1 to 200 parts by weight for each 100 parts by weight of the total weight of parts (A) and (B); and

(D) a hydrosilylation catalyst in an amount sufficient to promote curing of the composition;

where an index of refraction at 25°C for visible light having a wavelength of 589 nm passing through an object obtained by curing the curable organopolysiloxane composition is equal to or exceeds 1.5.

14. (Previously Presented) The curable organopolysiloxane composition of claim 13, where component (A) has a content of silicon-bonded aryl groups not less than 40 mole % of all silicon-bonded organic groups in component (A).

15. (Previously Presented) The curable organopolysiloxane composition of claim 13, where component (A) is an organopolysiloxane represented by the general formula:



where each R¹ comprises the same or different substituted or unsubstituted monovalent hydrocarbon groups, at least two R¹'s comprise alkenyl groups, at least one R¹ comprises an aryl group, and *n* is an integer from 5 to 1000.

16. (Previously Presented) The curable organopolysiloxane composition of claim 13, where light permeability at 25°C for visible light passing through an object obtained by curing the curable organopolysiloxane composition of claim 17 is equal to or exceeds 80%.

17. (Previously Presented) A curable organopolysiloxane composition comprising:

(A) a straight-chain organopolysiloxane having per molecule at least two silicon-bonded alkenyl groups and at least one silicon-bonded aryl group;

(B) a branched-chain organopolysiloxane with siloxane units represented by the general formula:



where R is a substituted or unsubstituted monovalent hydrocarbon group, and where component (B) has per molecule, at least one silicon-bonded alkenyl group and at least one silicon-bonded aryl group, and where component (B) is used in a weight ratio of 1/99 to 99/1 based on the weight of component (A);

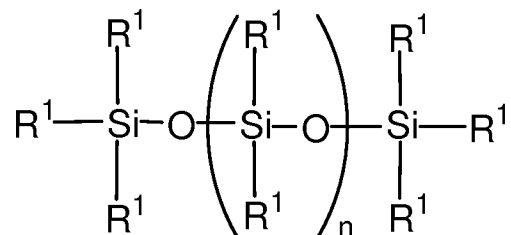
(C) an organopolysiloxane having per molecule at least two silicon-bonded hydrogen atoms, where component (C) is used in an amount of 1 to 200 parts by weight for each 100 parts by weight of the total weight of parts (A) and (B); and

(D) a hydrosilylation catalyst in an amount sufficient to promote curing of the composition;

where light permeability at 25°C for visible light passing through an object obtained by curing the curable organopolysiloxane composition is equal to or exceeds 80%.

18. (Previously Presented) The curable organopolysiloxane composition of claim 17, where component (A) has a content of silicon-bonded aryl groups not less than 40 mole % of all silicon-bonded organic groups in component (A).

19. (Previously Presented) The curable organopolysiloxane composition of claim 17, where component (A) is an organopolysiloxane represented by the general formula:



where each R^1 comprises the same or different substituted or unsubstituted monovalent hydrocarbon groups, at least two R^1 's comprise alkenyl groups, at least one R^1 comprises an aryl group, and n is an integer from 5 to 1000.

20. (Previously Presented) A semiconductor device comprising a light-emitting element, where said semiconductor device is coated with a cured coating made from a curable organopolysiloxane comprising:

(A) a straight-chain organopolysiloxane having per molecule at least two silicon-bonded alkenyl groups and at least one silicon-bonded aryl group;

(B) a branched-chain organopolysiloxane with siloxane units represented by the general formula:



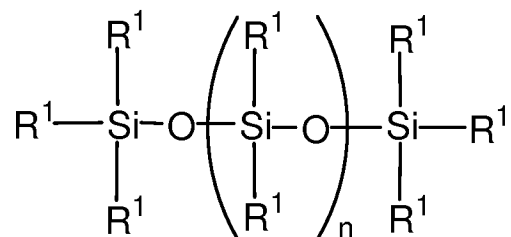
where R is a substituted or unsubstituted monovalent hydrocarbon group, and where component (B) has per molecule, at least one silicon-bonded alkenyl group and at least one silicon-bonded aryl group, and where component (B) is used in a weight ratio of 1/99 to 99/1 based on the weight of component (A);

(C) an organopolysiloxane having per molecule at least two silicon-bonded hydrogen atoms, where component (C) is used in an amount of 1 to 200 parts by weight for each 100 parts by weight of the total weight of parts (A) and (B); and

(D) a hydrosilylation catalyst in an amount sufficient to promote curing of the composition.

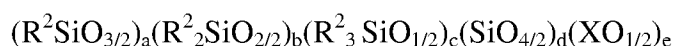
21. (Previously Presented) The curable organopolysiloxane composition of claim 20, where component (A) has a content of silicon-bonded aryl groups not less than 40 mole % of all silicon-bonded organic groups in component (A).

22. (Previously Presented) The curable organopolysiloxane composition of claim 20, where component (A) is an organopolysiloxane represented by the general formula:



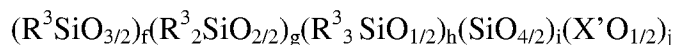
where each R^1 comprises the same or different substituted or unsubstituted monovalent hydrocarbon groups, at least two R^1 's comprise alkenyl groups, at least one R^1 comprises an aryl group, and n is an integer from 5 to 1000.

23. (Previously Presented) The curable organopolysiloxane composition of claim 20, where component (B) has an average unit formula:



where each R^2 is the same or different substituted or unsubstituted monovalent hydrocarbon group, 0.1 to 40 mole % of all R^2 's are alkenyl groups, more than 10 mole % of all R^2 's are aryl groups, X is a hydrogen atom or an alkyl group, a is a positive number, b is 0 or a positive number, c is 0 or a positive number, d is 0 or a positive number, e is 0 or a positive number, b/a is 0 to 10, c/a is 0 to 0.5, $d/(a + b + c + d)$ is 0 to 0.3, and $e/(a + b + c + d)$ is 0 to 0.4.

24. (Currently Amended) The curable organopolysiloxane composition of claim 20, where all or a portion of component (C) has an average unit formula:



where each R^3 is the same or different ~~alkenyl groups~~, substituted or unsubstituted monovalent hydrocarbon groups except for alkenyl groups, or hydrogen atoms; 0.1 to 40 mole % of all R^3 's are hydrogen atoms; more than 10 mole % of all R^3 's are aryl groups; X' is a hydrogen atom or an alkyl group, f is a positive number, g is 0 or a positive number, h is 0 or a positive number, i is 0 or a positive number, j is 0 or a positive number, g/f is 0 to 10, h/f is 0 to 0.5, $i/(f + g + h + i)$ is 0 to 0.3, and $j/(f + g + h + i)$ is 0 to 0.4.